


ATTACHMENT 1(g)

LIST OF ADDITIONAL SUBMITTED DOCUMENTS	ATTORNEY DOCKET NO.	APPLICATION NO.
	826.1034C2D2D2D	10/045,094
	FIRST NAMED INVENTOR	
	Shoji HAYASHIDA	

FILING DATE GROUP ART UNIT

January 15, 2002 2876

The following document(s) is/are listed in accordance with the duty of disclosure provisions of 37 CFR § 1.56, so that the Examiner may consider same should he deem any thereof to be material to examination of the subject application. Pursuant to 37 CFR 1.98(a)(2)(iv), a copy of any identified documents is provided.

It is requested that the Examiner acknowledge his consideration of document(s) below-listed by initialing same in the space provided adjacent each such application and that the Examiner sign and date this form at the bottom thereof to confirm such consideration having been given.

This submission in no way represents an admission that any of the information listed herein constitutes prior art with respect to the subject application and unless and until such prior art status is established, this submission is not a request that the information presented herein be printed on the face of any patent issuing from the subject application in which this information is being filed.

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NO.	DATE	NAME	CLASS	SUB-CLASS	FILING DATE
	AA						
	AB						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATION YES NO
	AC						
	AD						

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

TRANSLATION YES NO

<i>AK</i>	AE	Summons to Oral Proceedings mailed May 2, 2003 in the counterpart European Patent No. 416916 opposition, including preliminary opinion of the European Opposition Division regarding claim 1, 18 pages	X	
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EXAMINER	A hshik Kim	DATE CONSIDERED	4 - 3 - 04
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.